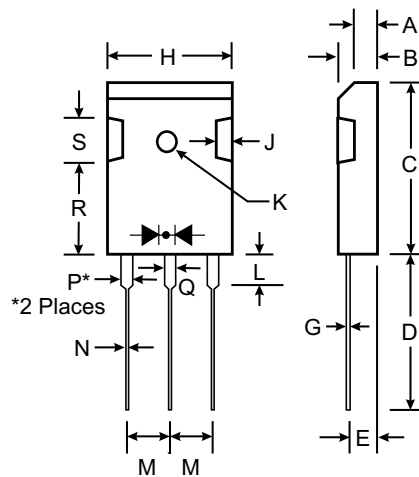


### Features

- Schottky Barrier Chip
- Guard Ring Die Construction for Transient Protection
- Low Power Loss, High Efficiency
- High Surge Capability
- High Current Capability and Low Forward Voltage Drop
- For Use in Low Voltage, High Frequency Inverters, Free Wheeling, and Polarity Protection Application
- Plastic Material - UL Flammability Classification 94V-0

### Mechanical Data

- Case: Molded Plastic
- Terminals: Plated Leads Solderable per MIL-STD-202, Method 208
- Polarity: As Marked on Body
- Weight: 5.6 grams (approx)
- Mounting Position: Any
- Marking: Type Number



TO-3P		
Dim	Min	Max
A	3.20	3.50
B	4.59	5.16
C	20.80	21.30
D	19.70	20.20
E	2.10	2.40
G	0.51	0.76
H	15.90	16.40
J	1.70	2.70
K	3.10 $\varnothing$	3.30 $\varnothing$
L	3.50	4.51
M	5.20	5.70
N	1.12	1.22
P	1.93	2.18
Q	2.97	3.22
R	11.70	12.80
S	4.30 Typical	
All Dimensions in mm		

### Maximum Ratings and Electrical Characteristics @ $T_A = 25^\circ\text{C}$ unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.  
For capacitive load, derate current by 20%.

Characteristic	Symbol	SBL 1630PT	SBL 1635PT	SBL 1640PT	SBL 1645PT	SBL 1650PT	SBL 1660PT	Unit
Peak Repetitive Reverse Voltage	$V_{RRM}$	30	35	40	45	50	60	V
Working Peak Reverse Voltage	$V_{RWM}$							
DC Blocking Voltage	$V_R$							
RMS Reverse Voltage	$V_{R(RMS)}$	21	24.5	28	31.5	35	42	V
Average Rectified Output Current (Note 1)	$I_o$	16						A
Non-Repetitive Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	$I_{FSM}$	250						A
Forward Voltage Drop @ $I_F = 8.0A, T_C = 25^\circ\text{C}$	$V_{FM}$	0.55				0.70		V
Peak Reverse Current at Rated DC Blocking Voltage @ $T_C = 25^\circ\text{C}$ @ $T_C = 100^\circ\text{C}$	$I_{RM}$	0.5				50		mA
Typical Junction Capacitance (Note 2)	$C_j$	700						pF
Typical Thermal Resistance Junction to Case (Note 1)	$R_{\theta Jc}$	3.5						K/W
Operating and Storage Temperature Range	$T_j, T_{STG}$	-65 to +150						$^\circ\text{C}$

- Notes: 1. Thermal resistance junction to case mounted on heatsink.  
2. Measured at 1.0 MHz and applied reverse voltage of 4.0V DC.

